APT40DQ120SG

Datasheet Ultrafast Soft Recovery Rectifier Diode

Final June 2018



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1 Revision History

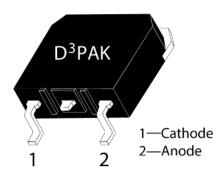
The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

1.1 Revision A

Revision A was published in June 2018. It is the first publication of this document.



2 Product Overview



2.1 Features

The following are key features of the APT40DQ120SG device:

- Ultra-fast recovery times
- Soft recovery characteristics
- Low forward voltage
- Low leakage current
- Avalanche energy rated
- RoHS compliant

2.2 Benefits

The following are benefits of the APT40DQ120SG device:

- Higher switching frequency
- Low switching losses
- Low noise (EMI) switching
- Higher reliability systems
- Increased system power density

2.3 Applications

The APT40DQ120SG device is designed for the following applications:

- Power Factor Correction (PFC)
- Anti-parallel diode
 - Switch-mode power supply
 - Inverters/converters
 - Motor controllers
- Freewheeling diode
 - Switch-mode power supply
 - Inverters/converters
- Snubber/clamp diode



3 Electrical Specifications

This section shows the electrical specifications for the APT40DQ120SG device.

3.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings for the APT40DQ120SG device.

All ratings: Tc = 25 °C unless otherwise specified.

Table 1 • Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit
VR	Maximum DC reverse voltage 1200		V
VRRM	Maximum peak repetitive reverse voltage	1200	
VRWM	Maximum working peak reverse voltage	1200	
IF(AV)	Maximum average forward current (Tc = 112 °C, duty cycle = 0.5) 40		А
F(RMS)	RMS forward current	63	
IFSM	Non-repetitive forward surge current (T _J = 45 °C, 8.3 ms)	210	
Eavl	Avalanche energy (1 A, 40 mH)	20	mJ
TJ , TSTG	Operating and storage temperature range	–55 to 175	°C
Τι	Lead temperature for 10 seconds	300	

The following table shows the thermal and mechanical characteristics of the APT40DQ120SG device.

Table 2 • Thermal and Mechanical Characteristics

Symbol	Characteristic	Min	Тур	Max	Unit
Rejc	Junction-to-case thermal resistance			0.61	°C/W
W⊤	Package weight		0.14		OZ
			4.0		g

3.2 Electrical Performance

The following table shows the static characteristics of the APT40DQ120SG device.

Table 3 • Static Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
VF	Forward voltage	IF = 40 A		2.8	3.4	V
		IF = 80 A		3.4		
		I _F = 40 A, T _J = 125 °C		2.1		
Irm	Maximum reverse leakage current	V _R = 1200 V			100	μA
		V _R = 1200 V, T _J = 125 °C			500	-
C	Junction capacitance, $V_R = 200 V$			36		рF



3.3 Dynamic Characteristics

The following table shows the dynamic characteristics of the APT40DQ120SG device.

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
trr	Reverse recovery time	IF = 1 A, diF/dt = -100 A/µs		26		ns
		V _R = 30 V, T _J = 25 °C				
trr	Reverse recovery time	IF = 40 A, diF/dt = -200 A/μs VR = 800 V, Tc = 25 °C		350		-
Qrr	Reverse recovery change			570		nC
Irrm	Maximum reverse			4		А
	recovery current					
trr	Reverse recovery time	IF = 40 A, diF/dt = -200 A/μs VR = 800 V, Tc = 125 °C		430		ns
Qrr	Reverse recovery charge			2200		nC
IRRM	Maximum reverse			9		А
	recovery current					
trr	Reverse recovery time	I _F = 40 A, di _F /dt = -1000 A/μs V _R = 800 V, T _c = 125 °C		210		ns
Qrr	Reverse recovery change			3400		nC
IRRM	Maximum reverse	_		29		А
	recovery current					

Table 4 • Dynamic Characteristics

3.4 Typical Performance Curves

This section shows the typical performance curves for the APT40DQ120SG device.

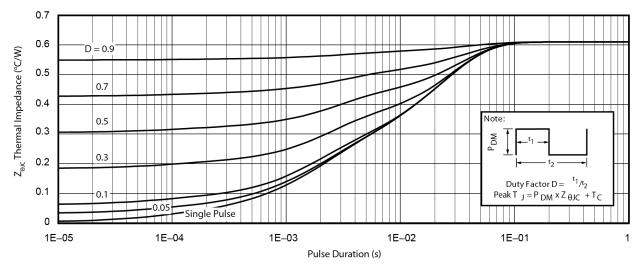
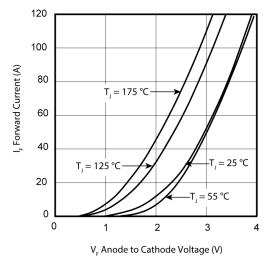


Figure 1 • Maximum Transient Thermal Impedance

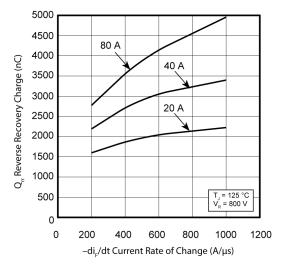


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Figure 2 • Forward Current vs. Forward Voltage









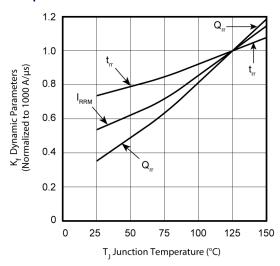


Figure 3 • trr vs. Current Rate of Change

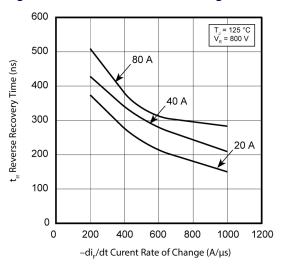
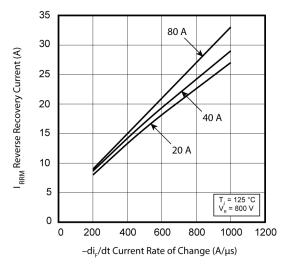


Figure 5 • IRRM vs. Current Rate of Change





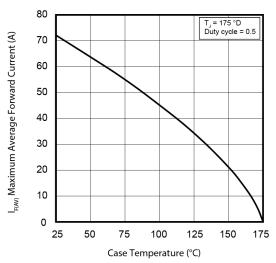
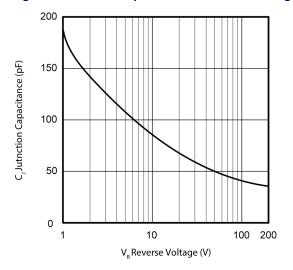




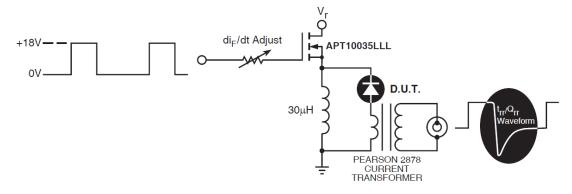
Figure 8 • Junction Capacitance vs. Reverse Voltage



3.5 Reverse Recovery Overview

The following illustration shows the diode test circuit for the APT40DQ120SG device.

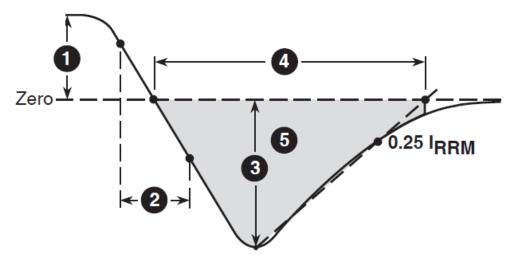
Figure 9 • Diode Test Circuit



The following illustration shows the diode reverse recovery waveform and definitions for the APT40DQ120SG device.







- 1. IF—Forward conduction current.
- 2. di_F/dt—Rate of diode current change through zero crossing.
- 3. IRRM—Maximum reverse recovery current.
- 4. trr—Reverse recovery time, measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through IRRM and 0.25 IRRM passes through zero.
- 5. Qrr—Area under the curve defined by IRRM and trr.



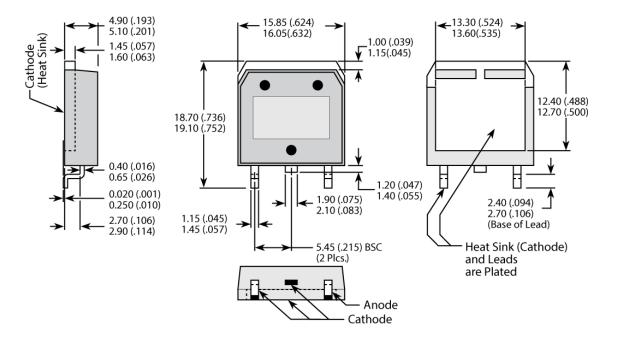
4 Package Specification

This section shows the package specification for the APT40DQ120SG device.

4.1 Package Outline Drawing

This section shows the D³PAK package drawing of the APT40DQ120SG device. Dimensions are in millimeters and (inches).

Figure 11 • Package Outline Drawing







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